#### TOYO LED ELECTRONICS LIN TED

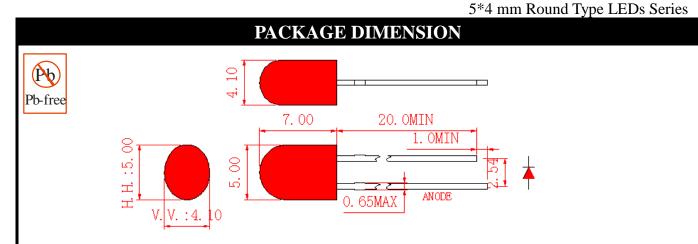


Room 1610, Hong Kong Plaza, 188 Connaught Road West, Hong Kong, Tel: (852) 2540 7288 Fax : (852) 2517 1797 Http://www.toyo-led.com

E-mail: sales@toyo-led.com



## P/N: TY-571UR3D100-1000(20)



#### **Selection Guide**

Part No.	Dice		Long Colon	Iv(mcd)(IF=20mA)			Viewing Angle
raft No.	Raw Material	Emitted Color Lens Color		MIN	TYP	MAX	(201/2)
TY-571UR3D100-1000(20)	AlGaInP	Red	Red Diffused	500	1000		H.H.: 100 °
				500	1000		V.V.: 50 °

#### Absolute Maximum Ratings(Ta=25C )

Item	Symbol	Maximum	Unit
Power Dissipation	Pd	60	mW
Peak Forward Current (1/10 Duty Cycle 0.1ms Pulse Width)	Ifp	160	mA
Forward Current	IFmax	25	mA
Reverse Voltage	VR	5	V
Operating / Storage Temperature Range	Topr / Tstg	-40 °C to +85 °C	

#### Electrical / Optical Characteristics(Ta=25C )

Item	Symbol	Min.	Тур.	Max.	Unit	Condition
Peak Wavelength	λp	-	631	-	nm	IF=20mA
Dominant Wavelength	λd	620	625	630	nm	IF=20mA
Forward Voltage	VF	1.80	2.20	2.60	V	IF=20mA
Capacitance	С	-	-	95	pF	VF=0V;f=1MHz
Reverse Current	Ir	-	-	10	uA	Vr=5V

NOTES:

All dimensions are in millimeter; 1.

- Tolerance is  $\pm 0.25$ mm unless other specified; Luminous intensity testing tolerance is  $\pm 10\%$ ; 2.
- Dominant Emission Wavelength testing tolerance is  $\pm 5\%$ ; 3.
- Specifications are subject to change without notice

## **TOYO LED ELECTRONICS LIMITED**



Room 1610, Hong Kong Plaza, 188 Connaught Road West, Hong Kong.Tel : (852) 2540 7288Fax : (852) 2517 1797Http://www.toyo-led.comE-mail : sales@toyo-led.com



### P/N: TY-571UR3D100-1000(20)

### 5\*4 mm Round Type LEDs Series

### **Typical Electro-Optical Characteristic Curve:**

### FIG. 1 Forward Current Vs. Forward Voltage

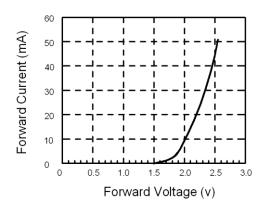


FIG. 3 Forward Current Vs. Temperature

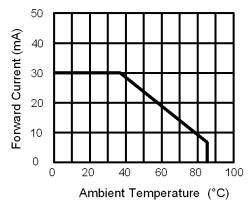
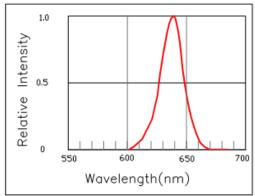


FIG. 5 Relative Intensity Vs. Wavelength



### FIG. 2 Relative Luminosity Vs. Forward Current

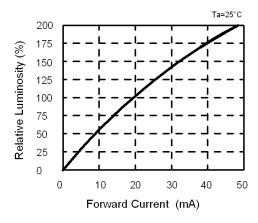
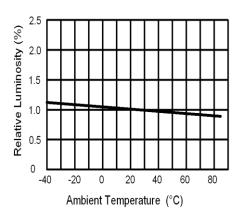


FIG. 4 Relative Luminosity Vs. Temperature





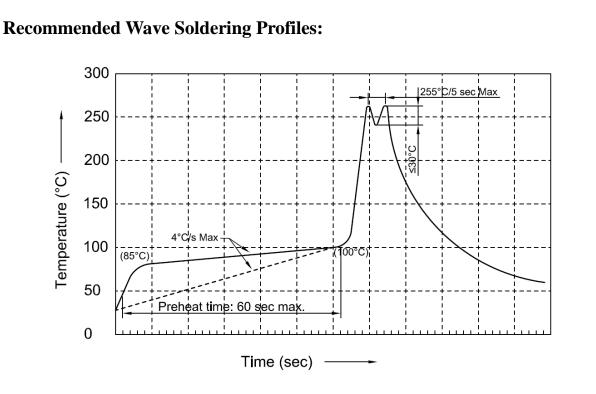
### **FOYO LED ELECTRONICS LIMITED**

Room 1610, Hong Kong Plaza, 188 Connaught Road West, Hong Kong.Tel : (852) 2540 7288Fax : (852) 2517 1797Http://www.toyo-led.comE-mail : sales@toyo-led.com



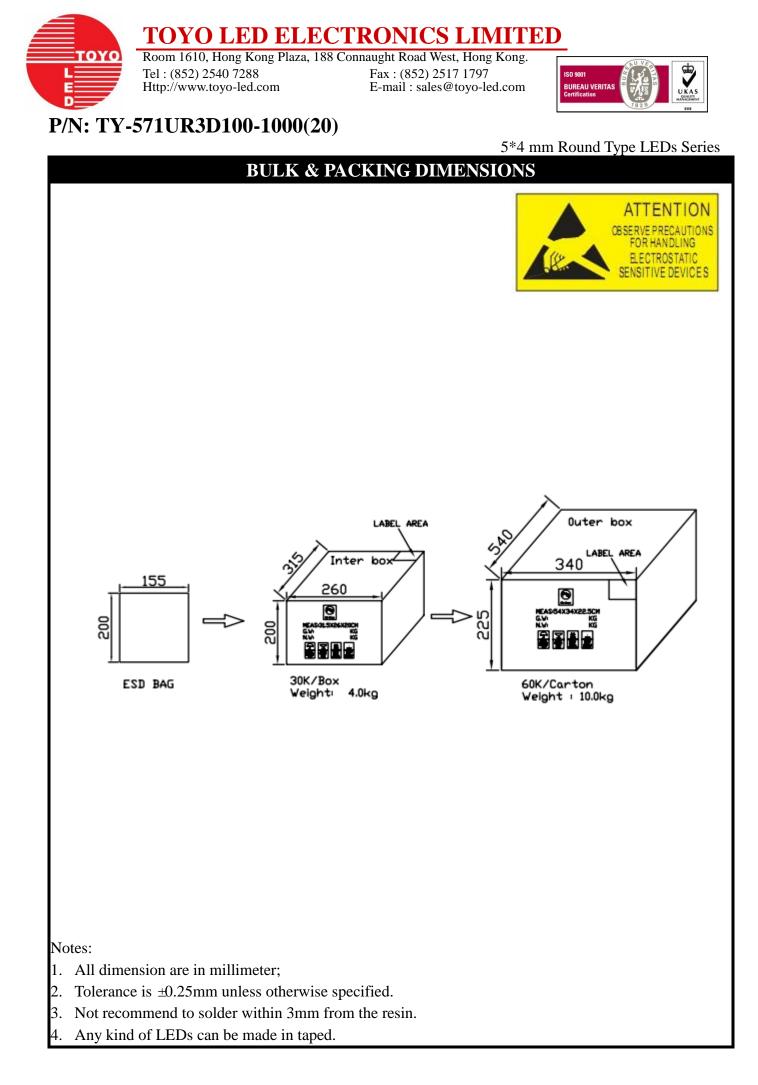
### P/N: TY-571UR3D100-1000(20)

### 5\*4 mm Round Type LEDs Series



Notes:

- 1. Recommend pre-heat temperature of  $105^{\circ}$ C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of  $260^{\circ}$ C.
- 2. Peak wave soldering temperature between 245-255°C for 3 sec (5 sec max).
- 3. Do not apply stress to the epoxy resin while the temperature is above  $85^{\circ}$ C.
- 4. Fixtures should not incur stress on the component when mounting and soldering process.
- 5. More than one wave soldering is not allowed..



# YO LED ELECTRONIC

τογο Tel: (852) 2540 7288 Http://www.toyo-led.com

Room 1610, Hong Kong Plaza, 188 Connaught Road West, Hong Kong. Fax: (852) 2517 1797 E-mail: sales@toyo-led.com



### P/N: TY-571UR3D100-1000(20)

#### 5\*4 mm Round Type LEDs Series

### **OTHER NOTES**

### **1.**Storage conditions:

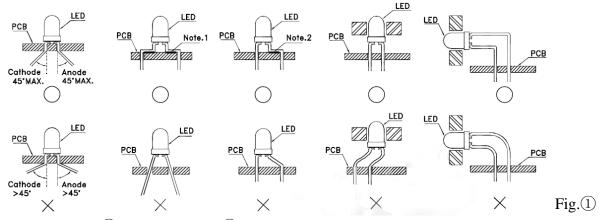
a. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.

b. LEDs should be stored with temperature  $\leq 30^{\circ}$  c and relative humidity  $\leq 60\%$ .

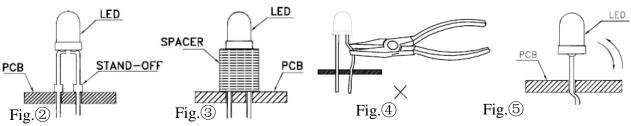
c. Product in the original sealed package is recommended to be assembled within 72 hours of

opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85-100°C.

2. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component. Lead-forming may be required to insure the lead pitch matches the pitch. Refer to the figure below for proper lead forming procedures. (Fig.(1))



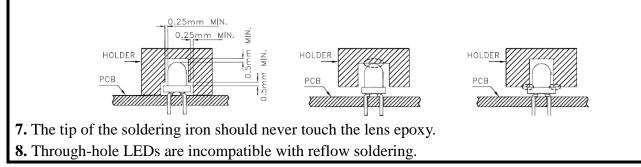
**3.** Use stand-offs (fig.2) or spacers (fig.3) to securely position the LED above the PCB.



4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB.(fig.(4))

**5.** Do not bend the leads more than twice. (fig. 5)

6. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.





## **TOYO LED ELECTRONICS LIMITED**

Room 1610, Hong Kong Plaza, 188 Connaught Road West, Hong Kong.Tel : (852) 2540 7288Fax : (852) 2517 1797Http://www.toyo-led.comE-mail : sales@toyo-led.com



### P/N: TY-571UR3D100-1000(20)

### 5\*4 mm Round Type LEDs Series

	<b>REVISION HISTORY</b>							
I								
	DATE	REVISION CONTENTS	VERSION					
	2015-05-15	New	А					